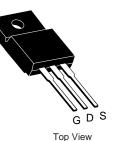
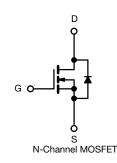


AP9990GP-HF-VB Datasheet N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	
60	0.005 at V _{GS} = 10 V	120	
00	0.013 at V _{GS} = 4.5 V	95	

TO-220 FULLPAK





ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted) Limit Symbol Unit Parameter V_{GS} ± 20 Gate-Source Voltage V T_C = 25 °C 120 Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^b$ I_D T_C = 100 °C 95^a **Pulsed Drain Current** I_{DM} 300 А Continuous Source Current (Diode Conduction) I_{S} 70^a 50 Avalanche Current I_{AS} Single Avalanche Energy (Duty Cycle \leq 1 %) L = 0.1 mH125 E_{AS} mJ T_C = 25 °C 136 Maximum Power Dissipation P_D W T_A = 25 °C 3^b, 8.3^{b, c} Operating Junction and Storage Temperature Range T_J, T_{stg} - 55 to 175 °C

THERMAL RESISTANCE RATINGS				
	Symbol	Typical	Maximum	Unit
$t \le 10 \text{ sec}$	R _{thJA}	15	18	°C/W
Steady State		40	50	
	R _{thJC}	0.85	1.1	
		$\begin{tabular}{ c c c c }\hline t \leq 10 & \text{sec} \\\hline \hline Steady State \\\hline \hline \end{array} R_{thJA}$	$\begin{array}{c c} t \leq 10 \text{ sec} \\ \hline \\ $	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

FEATURES

- 175 °C Junction Temperature
- TrenchFET[®] Power MOSFET
- Material categorization:



c. t ≤ 10 s.

A	3 °v	' Bse	mi
ww	w.VB	semi.	com

Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	60			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1	2	3	v
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	1 50		1	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125 °C			50	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250	1
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	60			А
Drain-Source On-State Resistance ^b		V _{GS} = 10 V, I _D = 20 A		0.005		
	Б	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.010		0
	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.015		Ω
		V _{GS} = 4.5 V, I _D = 15 A		0.013		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S
Dynamic	•		•			
Input Capacitance	C _{iss}			5650		
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		1120		pF
Reverse Transfer Capacitance	C _{rss}			525		
Total Gate Charge ^c	Qg			47	70	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 30 V, V_{GS} = 10 V, I_D = 50 A		10		nC
Gate-Drain Charge ^c	Q _{gd}			12		
Turn-On Delay Time ^c	t _{d(on)}			10	20	
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.6 Ω		15	25	200
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 50 A, V_GEN = 10 V, R_g = 2.5 Ω		35	50	ns
Fall Time ^c	t _f			20	30	
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)				
Pulsed Current	I _{SM}			300		Α
Diode Forward Voltage	V _{SD}	I _F = 20 A, V _{GS} = 0 V		1	1.5	V
	05					

SPECIFICATIONS (T₁ = 25 °C, unless otherwise noted)

Notes:

a. For design aid only; not subject to production testing.

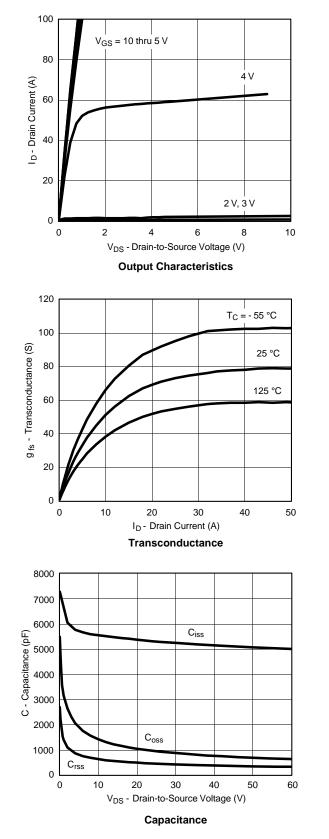
b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

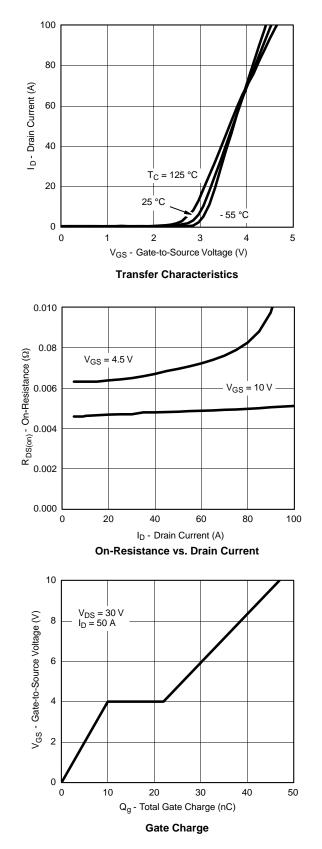
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



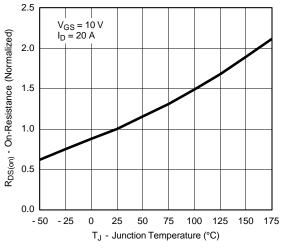
TYPICAL CHARACTERISTICS (25 °C unless noted)



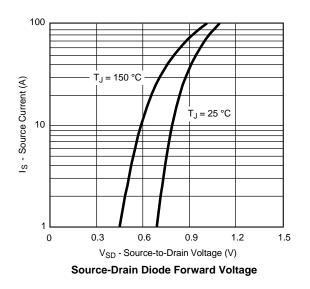




TYPICAL CHARACTERISTICS (25 °C unless noted)



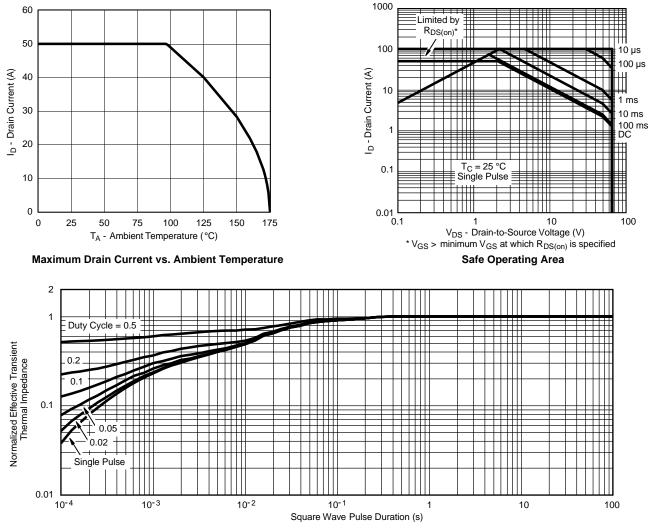
On-Resistance vs. Junction Temperature



AP9990GP-HF-VB



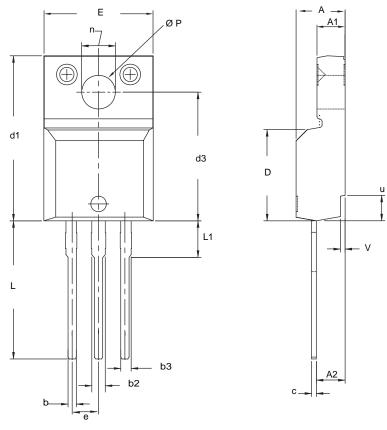
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK (HIGH VOLTAGE)



MIN. 4.570 2.570 2.510 0.622 1.229 1.229 0.440 8.650 15.88	MAX. 4.830 2.830 2.850 0.890 1.400 0.629 9.800	MIN. 0.180 0.101 0.099 0.024 0.048 0.048 0.017 0.341	MAX. 0.190 0.111 0.112 0.035 0.055 0.055 0.055 0.025 0.386	
2.570 2.510 0.622 1.229 1.229 0.440 8.650	2.830 2.850 0.890 1.400 1.400 0.629 9.800	0.101 0.099 0.024 0.048 0.048 0.048	0.111 0.112 0.035 0.055 0.055 0.055 0.025	
2.510 0.622 1.229 1.229 0.440 8.650	2.850 0.890 1.400 1.400 0.629 9.800	0.099 0.024 0.048 0.048 0.017	0.112 0.035 0.055 0.055 0.025	
0.622 1.229 1.229 0.440 8.650	0.890 1.400 1.400 0.629 9.800	0.024 0.048 0.048 0.017	0.035 0.055 0.055 0.025	
1.229 1.229 0.440 8.650	1.400 1.400 0.629 9.800	0.048 0.048 0.017	0.055 0.055 0.025	
1.229 0.440 8.650	1.400 0.629 9.800	0.048 0.017	0.055 0.025	
0.440 8.650	0.629 9.800	0.017	0.025	
8.650	9.800			
		0.341	0.386	
15.88	16 100		0.000	
	16.120	0.622	0.635	
12.300	12.920	0.484	0.509	
10.360	10.630	0.408	0.419	
2.54 BSC		0.100 BSC		
13.200	13.730	0.520	0.541	
3.100	3.500	0.122	0.138	
6.050	6.150	0.238	0.242	
3.050	3.450	0.120	0.136	
2.400	2.500	0.094	0.098	
0.400	0.500	0.016	0.020	
	10.360 2.54 13.200 3.100 6.050 3.050 2.400	10.360 10.630 2.54 BSC 13.730 3.100 3.500 6.050 6.150 3.050 3.450 2.400 2.500	10.360 10.630 0.408 2.54 BSC 0.100 13.200 13.730 0.520 3.100 3.500 0.122 6.050 6.150 0.238 3.050 3.450 0.120 2.400 2.500 0.094	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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